

IAP20 Rec'd PCT/PTO 23 MAY 2006

APPLICATION DATA SHEET**Applicant Information**

Inventor One Given Name:: Kensuke
Family Name:: NAKAMURA
Name Suffix::
Postal Address Line One:: c/o Mitsui Mining & Smelting Co., Ltd.
Postal Address Line Two:: Copper Foil Sector Copper Foil Division
Postal Address Line Three:: 656-2, Kamakurabashi
City:: Ageo-shi
State or Province:: Saitama
Country:: Japan
Postal or Zip Code 3620013
Citizenship Country:: Japan

Inventor Two Given Name:: Tetsuro
Family Name:: SATO
Name Suffix::
Postal Address Line One:: c/o Mitsui Mining & Smelting Co., Ltd.
Postal Address Line Two:: Copper Foil Sector Copper Foil Division
Postal Address Line Three: 656-2, Kamakurabashi
City:: Ageo-shi
State or Province:: Saitama
Country:: Japan
Postal or Zip Code 3620013
Citizenship Country:: Japan

Correspondence Information

Correspondence Customer Number:: 06449

Application Information

Title Line One::MULTILAYERED PRINTED WIRING BOARD AND
Title Line Two:: MANUFACTURING METHOD THEREOF
Total Drawing Sheets:: 22
Formal Drawings?:: New
Application Type:: Utility
Docket Number:: 3209-115

Secrecy Order in Parent Appl?:: No

Representative Information

Representative Customer Number:: The practitioners associated
Representative Customer Number:: with customer number 06449

Domestic Priority Information

This application is a:: 371 of
>Application One::PCT/JP2004/018355
Filing Date:: December 9, 2004
Patent Number::

Foreign Priority Information

Foreign Application One:: JP2003-418376
Filing Date:: December 16, 2003
Country:: Japan
Priority Claimed:: Yes

Assignment Information

Assignee name:: Mitsui Mining & Smelting Co., Ltd.
Street of mailing address:: 11-1, Osaki 1-chome
City of mailing address:: Shinagawa-ku
State or Province of
mailing address:: Tokyo
Country of mailing address:: Japan
Postal or Zip Code of
mailing address:: 141-8584